

BLW91

U.H.F. POWER TRANSISTOR

N-P-N silicon planar epitaxial transistor suitable for transmitting applications in class-A, B or C in the u.h.f. and v.h.f. range for a nominal supply voltage of 28 V. The transistor is resistance stabilized and is guaranteed to withstand infinite VSWR at rated output power. High reliability is ensured by a gold sandwich metallization.

The transistor is housed in a 1/4" capstan envelope with a ceramic cap. All leads are isolated from the stud.

QUICK REFERENCE DATA

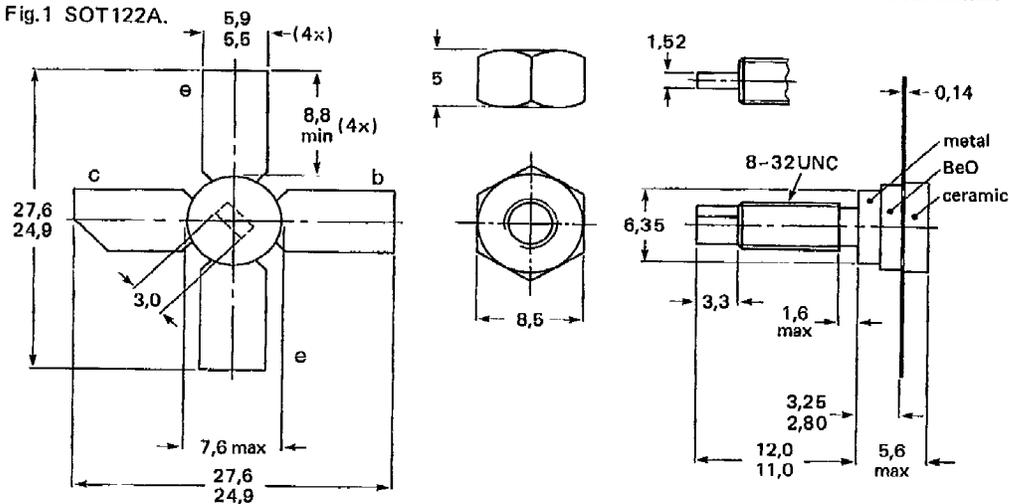
R.F. performance up to $T_h = 25^\circ\text{C}$ in an unneutralized common-emitter class-B circuit

mode of operation	V_{CE} V	f MHz	P_L W	G_p dB	η %
c.w.	28	470	10	>9	>60

MECHANICAL DATA

Dimensions in mm

Fig.1 SOT122A.



Torque on nut: min. 0,75 Nm
 (7,5 kg cm)
 max. 0,85 Nm
 (8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,2 mm.
 Mounting hole to have no burrs at either end.
 De-burring must leave surface flat; do not chamfer or
 countersink either end of hole.

When locking is required an adhesive is preferred instead of a lock washer.

PRODUCT SAFETY This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

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RATINGS

Limiting values in accordance with the Absolute Maximum System

Collector-emitter voltage

(peak value); $V_{BE} = 0$

open base

V_{CESM} max. 60 V

V_{CEO} max. 30 V

V_{EBO} max. 4 V

Emitter-base voltage (open collector)

Collector current

d.c. or average

$I_C; I_{C(AV)}$ max. 1,5 A

I_{CM} max. 3,5 A

(peak value); $f > 1$ MHz

P_{tot} max. 30 W

Total power dissipation up to $T_{mb} = 35$ °C

P_{rf} max. 32,5 W

R.F. power dissipation ($f > 1$ MHz); $T_{mb} = 25$ °C

T_{stg} -65 to +150 °C

Storage temperature

T_j max. 200 °C

Operating junction temperature

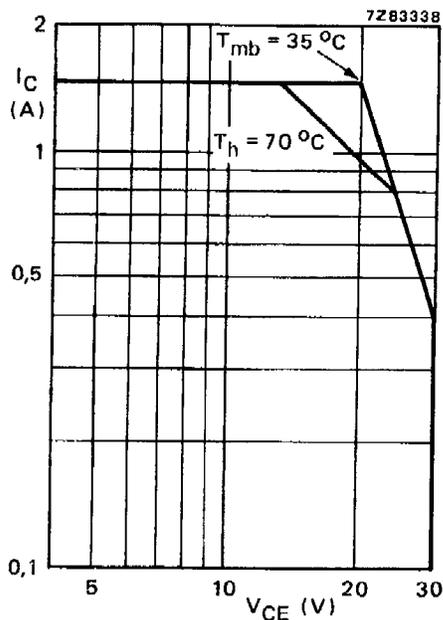


Fig. 2 D.C. SOAR.

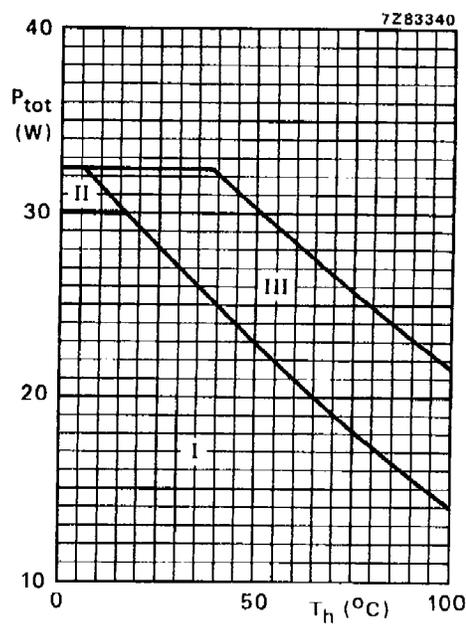


Fig. 3 Power derating curves vs. temperature.

I Continuous d.c. operation

II Continuous r.f. operation

III Short-time operation during mismatch

THERMAL RESISTANCE (dissipation = 10 W; $T_{mb} = 76$ °C, i.e. $T_h = 70$ °C)

From junction to mounting base (d.c. and r.f. dissipation)

$R_{th\ j-mb}$ = 6,2 K/W

From mounting base to heatsink

$R_{th\ mb-h}$ = 0,6 K/W

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$

Collector-emitter breakdown voltage

$V_{BE} = 0; I_C = 10\text{ mA}$

$V_{(BR)CES} > 60\text{ V}$

Collector-emitter breakdown voltage

open base; $I_C = 50\text{ mA}$

$V_{(BR)CEO} > 30\text{ V}$

Emitter-base breakdown voltage

open collector; $I_E = 4\text{ mA}$

$V_{(BR)EBO} > 4\text{ V}$

Collector cut-off current

$V_{BE} = 0; V_{CE} = 30\text{ V}$

$I_{CES} < 4\text{ mA}$

Second breakdown energy; $L = 25\text{ mH}; f = 50\text{ Hz}$

open base

$R_{BE} = 10\text{ }\Omega$

$E_{SBO} > 2\text{ mJ}$

$E_{SBR} > 2\text{ mJ}$

D.C. current gain *

$I_C = 0,6\text{ A}; V_{CE} = 5\text{ V}$

h_{FE} typ. 40
10 to 100

Collector-emitter saturation voltage *

$I_C = 2,0\text{ A}; I_B = 0,4\text{ A}$

V_{CEsat} typ. 1,0 V

Transition frequency at $f = 500\text{ MHz}$ *

$-I_E = 0,6\text{ A}; V_{CB} = 28\text{ V}$

$-I_E = 2,0\text{ A}; V_{CB} = 28\text{ V}$

f_T typ. 1,2 GHz

f_T typ. 1,0 GHz

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 28\text{ V}$

C_C typ. 17 pF

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 20\text{ mA}; V_{CE} = 28\text{ V}$

C_{re} typ. 8,5 pF

Collector-stud capacitance

C_{cs} typ. 1,2 pF